



#	Layer	Thickness	Description	Dk	Df	Note
	Top Solder	0.015mm	Soldermask IPC-SM840	3,5	0,028	used on rigid parts
1	Top Side	0.030mm	Starting foil 1/4oz. after plating and processing			
		0.065mm	Prepreg IPC-4101/21	3,2	0,02	FR-4.0
2	Inner Layer 1	0.035mm	ED Base Copper			
		0.710mm	Core IPC-4101/21	4,7	0,02	FR-4.0
3	Inner Layer 2	0.035mm	ED Base Copper			
		0.065mm	Prepreg IPC-4101/21	3,2	0,02	FR-4.0
4	Bottom Side	0.030mm	Starting foil 1/4oz. after plating and processing			
	Bottom Solder	0.015mm	Soldermask IPC-SM840	3,5	0,028	used on rigid parts

Total thickness: 1.000mm

notes:

Final copper thickness according to IPC-6012

Please regard to our sectional design rules:
 ► www.we-online.com

HDI4_1-2-1_1,00_35_V2.12			
PCB Thickness Tolerance: ± 10%			
customer		created	
pcb name		approved	
engineer		format	A4, landscape
date			
Template Revision: 02/2021 by Andreas Schilpp / Michael Kress / Werner Öchslen			

